

U.S. UTILITY Patent Application

PATENT NUMBER and
ISSUE DATE

APPL NUM 10017490	FILING DATE 12/14/2001	CLASS 174	SUBCLASS 117F	GAU 2831	EXAMINER Chau Nguyen
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**APPLICANTS: Segall Daniel; Hilton Iris; Fales-Bond Sharon; Pennace John;

**CONTINUING DATA VERIFIED: yes/cn
THIS APPLN CLAIMS BENEFIT OF 60/311,187 08/09/2001

** FOREIGN APPLICATIONS VERIFIED: none/cn

PG-PUB ☐ DO NOT PUBLISH ☐ RESCIND ☐

Foreign priority claimed ☐ yes ☒ no
35 USC 119 conditions met ☐ yes ☒ no

ATTORNEY DOCKET NO
6308

Verified and Acknowledged Examiners's initials

TITLE : Conductive composite formed of a thermoset material

U.S. DEPT. OF COMM./PAT. & TM.-PTO-436L (Rev. 12/94)

NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
		Total Claims	Print Claim for O.G.
Assistant Examiner		DRAWING	
		Sheet/Dwg.	Fig./Dwg.
Primary Examiner		Print Fig.	
PREPARED FOR ISSUE		Application Examiner	
ISSUE FEE Amount Due Date Paid <input type="checkbox"/> TERMINAL DISCLAIMER		WARNING: The information disclosed herein may be restricted. Unauthorized disclosure may be prohibited by the United States Code Title 35, Sections 122, 181 and 368, Possession outside the U.S. Patent & Trademark Office is restricted to authorized employees and contractors only.	
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